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Optical Flow Cryostat - Helitran[®]

The LT3-WMX-1SS offers a wide range of flexibility at a reasonable cost. This high performance systems offers an all stainless steel constructed vacuum shroud along with a welded stainless steel instrumentation skirt. This system is capable of achieving vacuum levels of 10-7 Torr with an appropriate vacuum system. The nickel plated copper radiation shield provides low emissivity which is ideal for low temperature experiments.

Applications

- Optical- UV, Vis, IR
- Raman
- FTIR
- Photoluminescence
- Deep Level Transient Spectroscopy (DLTS)
- Elecotro and Magneto Optical
- Hall Measurements
- Diamond Anvil Cell
- Electrical and Magnetic Susceptibility
- Mastrix Isolation
- Mossbauer

Features

- Welded Stainless Steel Construction
- Large Clear View Optical Windows (1.25 in)
- Large Sample Viewing Angle for Optical Collection (F/0.8)
- Matrix Heat Exchange
- Coaxial Shield Flow Transfer Line
- 4K Liquid Helium Operation (1.7K with Pumping)/ 77K with LN2
- 0.7 LL/hr Liquid Helium Consumption at 4.2K
- Precision Flow Control
- Fully Customizable

Typical Configuration

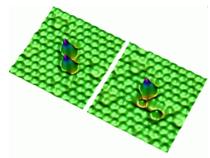
- Cold head (LT3-WMX-1)
- Coaxial Shield Flow Transfer Line
- Stainless steel instrumentation skirt
- Dewar Adapter
- Flow Meter Panel for Helium Flow Control and Optimization
- Welded stainless steel vacuum shroud for optical and electrical experiments (WMX-1SS)
- Nickel Plated OFHC Copper Radiation Shield
- Instrumentation for temperature measurement and control:
 - 10 pin UHV feed through 36 ohm thermofoil heater (wire wrapped) Silicon diode sensor curve matched to (±0.5K) for control Calibrated silicon diode sensor (±12 mk) with 4 in. free length for accurate sample measurement.
- Wiring for electrical experiments: 10 pin hermetic feed through 4 copper wires
- Sample holder for optical and electrical experiments
- Temperature Controller

Options and Upgrades

- High Flow Transfer Line
- High Temperature Interface (450K and 800K)
- Custom temperature sensor configuration (please contact our sales staff
- Custom wiring configurations (please contact our sales staff)



The above picture shows LT3B $\ensuremath{\mathsf{Helitran}}\xspace$ with a radiation shield.



Single Molecule Chemistry

Courtesy of Prof. Wilson Ho, UC Irvine



Cooling Technology

	LT4	Open Cycle Cryocooler	
	Refrigeration Type	Liquid Helium/Nitrogen Flow	
	Liquid Cryogen Usage	Helium, Nitrogen Compatible	
Temperature*			
	LT4	<4.2K-350K	
	With 800K Interface	(Base Temp + 2K) - 700K	
	With 450K Interface	Base Temp - 450K	
	Stability	<2mK (with properly tuned flow)	

*Based on bare cold head with a closed radiation shield, and no additional sources of experimental or parasitic heat load

Sample Space

	Diameter	36 mm (1.43 in.)	
	Height	39 mm (1.53 in.)	
	Sample Holder Attachment	1/4 - 28 screw	
	Sample Holder	www.arscryo.com/Products/ SampleHolders.html	
Optical Access			
	Window Ports	5 - 90° Apart	
	Diameter	41 mm (1.63 in)	
	Clear View	32 mm (1.25 in)	
	#/F	1	
	Window Material	www.arscryo.com/Products/ WindowMaterials.html	

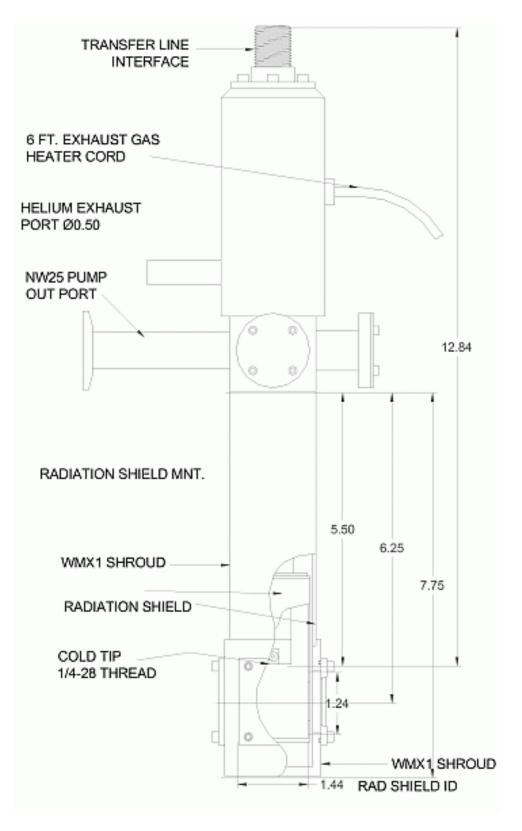
Temperature Instrumentation and Control (Standard)

	Heater	36 ohm Thermofoil Heater anchored to the coldtip		
	Control Sensor	Curve Matched Silicon Diode installed on the coldtip		
	Sample Sensor	Calibrated Silicon Diode with free length wires		
	Contact ARS for other opt	tions		
Insti	rumentation Access			
	Instrumentation Skirt	Welded, Stainless Steel		
	Pump out Port	1 - NW 25		
	Instrumentation Ports	2		
	Instrumentation Wiring	Contact sales staff for options		
Vacı	um Shroud			
	Material	Welded Stainless Steel		
	Length	338 mm (13.3 in)		
	Diameter	79 mm (3.12 in) at the sample space		
	Width	56 mm (2.21 in) at the sample space		
Rad	ation Shield			
	Material	OFHC Copper, Nickel Plated		
	Attachment	Threaded		
	Optical Access	0, 2, 4, or 5 (customer specified)		
Cryostat Footprint				
	Overall Length	383 mm (15 in)		

Cryostat Model	LT3		
Cryogen	Liquid Helium		Liquid Nitrogen
Base Temperature	4.2K	<2K with Pumping	77K
Nominal Helium Consumption at 4.2K	0.7 LL/hr	-	
Cooling Capacity	0.7 LL/hr	2 LL/hr	
4.2K	0.5W	1.5W	
20K	3.0W	8.0W	
50K	7W	20W	
Maximum Temperature	450K with cold ga	as through transfer line	
Cooldown Time	:	20 min	
Weight	0.9	kg (2 lbs)	



LT3-WMX-1SS Outline Drawing



Advanced Features of LT3 Helitran®

The Helitran[®] has been designed for high performance with advanced features not normally found in traditional open cycle cryostats. A detailed description of the <u>Matrix Heat Exchanger</u>, the <u>Adjustable Impedance Valve</u> and the <u>Coaxial Transfer Line</u> is presented in this paper.

Helium Consumption

Conventional Helium Flow Cryostats do not incorporate extended surface Heat Exchangers (at the sample mount) for cost reasons. The liquid helium is contained in a reservoir similar to a copper cup over the sample mount. As the helium boils and evaporates only the latent heat of vaporization is used to cool the sample mount, there is no provision to capture the enthalpy of the gas as it escapes from the cryostat at 4.2K regardless of the sample temperature. The cooling power of the gas is wasted. Enthalpy of Helium gas from 4.2 to 300K is substantial at 1542 Joules/gm.

The Helitran[®] incorporates an extended surface tip heat exchanger (Matrix Heat Exchanger) which provides efficient heat transfer between the helium and the sample mount. The Liquid helium flows through this heat exchanger and as the latent heat of vaporization cools the sample mount, the liquid evaporates, the gas continues to flow through the exchanger providing additional cooling (capturing the enthalpy of the gas) to the sample mount. If the flow is optimized the helium gas will exit the Matrix Heat Exchanger at a temperature equal to the sample temperature.

Helium usage is dramatically reduced as reported by J. B. Jacobs in Advances in Cryogenic Engineering, Volume 8, 1963, Page 529 as follows:

Amount of Cryogenic fluid required to cool metals (Liters/Kg.) to 4.2K.

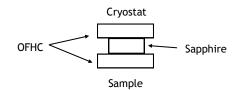
Cryogen	⁴He	⁴He
Initial Temperature of 1 Kg of Copper.	300K	77K
Final Temperature of 1 Kg of Copper,	4.2K	4.2K
Using the latent heat of vaporization only. (Inefficient Heat Transfer)	31.1 Liters of Helium	2.16 Liters of Helium
Using the Enthalpy of Gas. (Efficient Heat Transfer)	0.79 Liters of Helium	0.15 Liters of Helium

From this it is clear that for <u>any</u> sample size the consumption of He during initial cooldown is 40 times higher without an extended surface cryostat tip heat exchanger from 300K (room temperature) to 4.2K and 14 times higher when cooling from 77K to 4.2K.

Temperature Range

Sub 4.2K Operation: The temperature of helium drops to 1.8K when the pressure is reduced across an Adjustable Impedance Valve. Pumping on a reservoir, as in a traditional system is not practical as all the helium will evaporate rather quickly. In the Helitran[®] the suction is applied against the Impedance Valve by attaching a vacuum pump, this reduces the pressure of the helium as it flows through the Matrix Heat Exchanger , The matrix heat exchanger and the conductively coupled sample mount are cooled to below 1.8K.

800K Operation: The high temperature can be achieved by incorporating a thermal switch, composed of a sapphire and OFHC copper arrangement as shown below. The unique property of sapphire is utilized, where its thermal conductivity is equal to that of copper from 4-300K but it becomes a thermal insulator above 300K. The high cooling power of the Matrix Heat exchanger protects the cryostat.



Temperature Stability

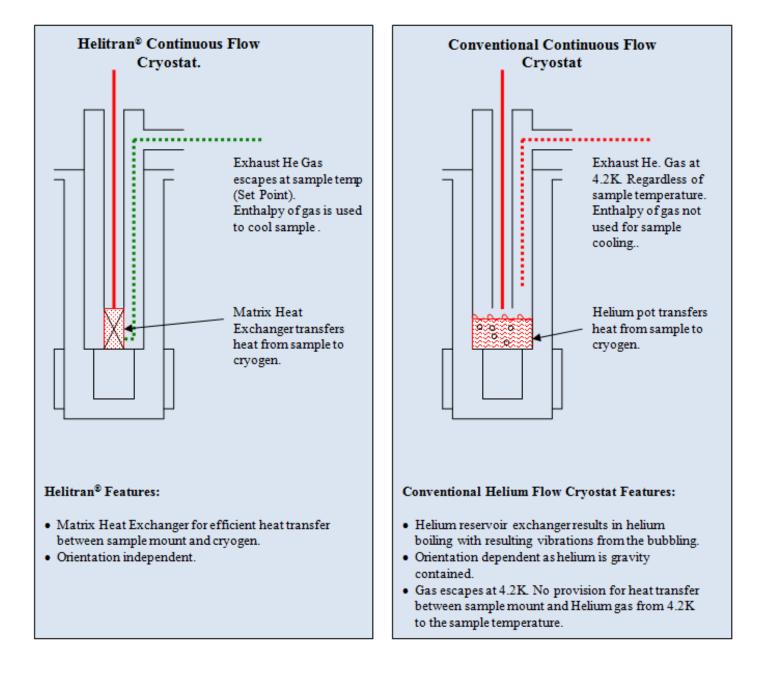
Conventional helium flow cryostats utilize a capillary tube in a vacuum jacket with superinsulation to reduce the radiant heat load. However as the helium absorbs radiant heat the liquid is vaporized and forms bubbles of gas which have a larger volume than the liquid thus forming a temporary block to the flow of the liquid called "vapor binding". At the delivery end of the transfer line this results in the liquid/gas mixture being delivered in spurts with accompanying pressure and temperature cycling.

The coaxial flow transfer line incorporates a shield flow (See figure) surrounding the tip flow for the entire length of the transfer line. The entrance to the coaxial shield flow tube is provided with a nozzle which results in a pressure and corresponding temperature drop in the shield flow which subcools the tip flow in the center tube. This sub-cooling prevents boiling and gas bubble formation in the helium, even at very low flow rates. The Helium is delivered at the sample end with the desired temperature stability and low vibrations.



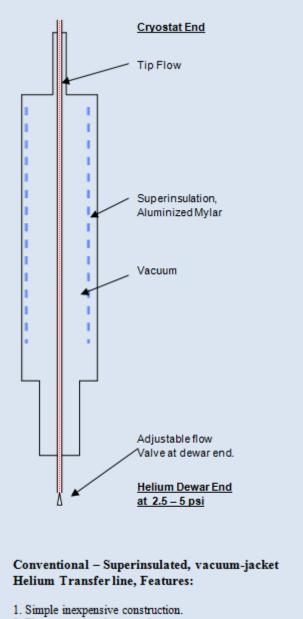


Cryostat Design Features

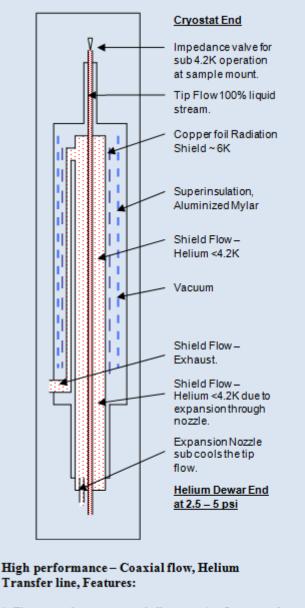




Helium Flow Transfer Line Features



- 2. Flow control at dewar end.
- 3. Vacuum Jacket.
- 4. Superinsulation, Aluminized mylar. Provides insulation.
- Percentage of liquid / gas mixture depends on helium flow rate.



- Flow control at cryostat end allows precise flow control (cooling power) at sample. Also permits lower temperature during sub 4.2K operation.
- Shield flow enters the outer tube through an expansion nozzle, the resulting pressure and temperature drop sub cools the tip flow.
- Shield flow is surrounded by copper foil radiation shield plus superinsulation in vacuum jacket.
- Sub cooled tip flow is delivered as 100% liquid at very precise and low flow rate. No "Vapor Binding".